

APPROVAL SHEET

RFDIP Series – 2012(0805)- RoHS Compliance

MULTILAYER CERAMIC DIPLEXER

Halogens Free Product

829 MHz & 2.2 GHz Band RF Application

P/N: RFDIP2012090GM1T58

*Contents in this sheet are subject to change without prior notice.



FEATURES

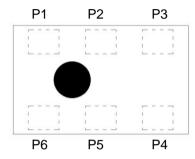
- 1. Miniature footprint: 2.0 X 1.2 X 0.90 mm³.
- 2. Low insertion loss
- 3. LTCC process

APPLICATIONS

- 1. 698~960 and 1710~2690MHz band for diplexer applications
- 2. GSM, DCS, PCS related applications

CONSTRUCTION

Top view



PIN	Connection	PIN	Connection
1	Lower Freq. Port	ower Freq. Port 4 GND	
2	GND	5	Common Port
3	Higher Freq. Port	6	GND

DIMENSIONS

	Figure	Symbol	Dimension (mm)
	<u>_</u>	L	2.00 ± 0.15
Top view ≥		W	1.25 ± 0.15
	Side view	Т	0.90 ± 0.10
Bottom view	А	0.35 ± 0.10	
Bottom view		В	0.30 ± 0.10
	CBA	С	0.65 ± 0.10
Side view		D	0.60 ± 0.10
		E	0.275 ± 0.10



ELECTRICAL CHARACTERISTICS

RFDIP2012090GM1T58	Specification		
Frequency range	698~960 MHz	1710~2690 MHz	
Insertion Loss	0.40 dB max. at 25 °C 0.45 dB max. at -40~+85 °C	0.55 dB max. at 25 °C 0.65 dB max. at -40~+85 °C	
Attenuation	13 dB min. @1710~2690 MHz	19 dB min. @698~960 MHz	
Isolation	13 dB min. @1710~2690 MHz	19 dB min. @698~960 MHz	
VSWR	2.0 max.		
Impedance	50Ω		
Moisture sensitivity levels	LEVEL 1 (Refer to : IPC/JEDEC J-STD-020)		

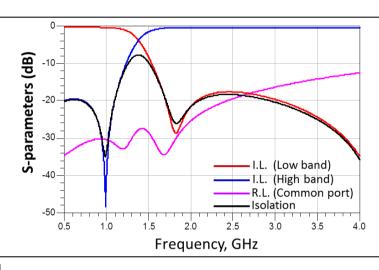
Operating & Storage Condition (Component)

Operation Temperature Range: -40 \sim +85 $^{\circ}$ C Storage Temperature Range: -40 \sim +85 $^{\circ}$ C

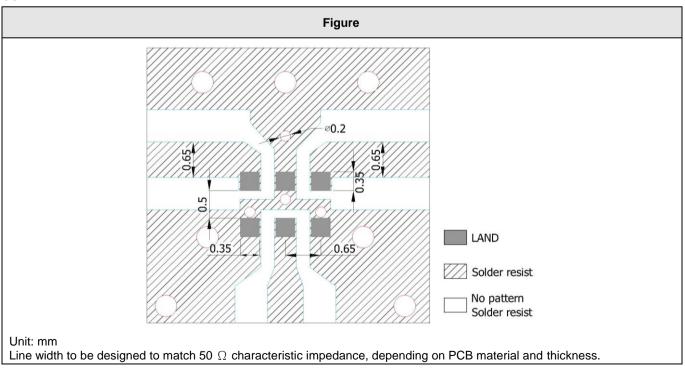
Storage Condition before Soldering (Included packaging material)

Storage Temperature Range: +5 ~ +40 °C Humidity: 30 to 70% relative humidity

Typical Electrical Chart



SOLDER LAND PATTERN





RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature : 235 ± 5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time : 2 ± 0.5 sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder : Sn3Ag0.5Cu for lead-free	
Leaching	*Solder bath temperature: 260 ± 5°C	Loss of metallization on the edges of each
(Resistance to	*Leaching immersion time : 30 \pm 0.5 sec	electrode shall not exceed 25%.
dissolution of	Solder : SN63A	
metallization)		
IEC 60068-2-58		
Resistance to soldering heat	*Preheating temperature : 120~150℃,	No mechanical damage.
JIS C 0050-5.4	1 minute.	Electrical specification shall satisfy the
	*Solder temperature: 270±5°C	descriptions in electrical characteristics under
	*Immersion time: 10±1 sec	the operational temperature range within -40
	Solder : Sn3Ag0.5Cu for lead-free	~ 85°C.
	Measurement to be made after keeping at	Loss of metallization on the edges of each
		electrode shall not exceed 25%.
	room temperature for 24±2 hrs	
Drop Test	*Height: 75 cm	No mechanical damage.
JIS C 0044	*Test Surface : Rigid surface of concrete or	Electrical specification shall satisfy the
Customer's specification.	steel.	descriptions in electrical characteristics under
	*Times: 6 surfaces for each units; 2 times	the operational temperature range within -40
	for each side.	~ 85°C.
Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude: 1.5mm	Electrical specification shall satisfy the
	*Test times : 6hrs.(Two hrs each in three	descriptions in electrical characteristics under
	mutually perpendicular directions)	the operational temperature range within -40
		~ 85°C.
Adhesive Strength	*Deconicies force :	N
of Termination	*Pressurizing force :	No remarkable damage or removal of the
JIS C 0051- 7.4.3	5N(≤0603) ; 10N(>0603)	termination.
Bending test	*Test time: 10±1 sec	
JIS C 0051- 7.4.1	The middle part of substrate shall be	No mechanical damage.
0.0001 7.1.1	pressurized by means of the pressurizing rod	Electrical specification shall satisfy the
	at a rate of about 1 mm/s per second until the	descriptions in electrical characteristics under
	deflection becomes 1mm/s and then pressure	the operational temperature range within -40
	shall be maintained for 5±1 sec.	~ 85°C.
	Measurement to be made after keeping at	
	room temperature for 24±2 hours	

Temperature cycle JIS C 0025	 30±3 minutes at -40°C±3°C, 10~15 minutes at room temperature, 30±3 minutes at +85°C±3°C, 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs 	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
High temperature JIS C 0021	*Temperature: 85°C±2°C *Test duration: 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Humidity (steady conditions) JIS C 0022	*Humidity: 90% to 95% R.H. *Temperature: 40±2°C *Time: 1000+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs % 500hrs measuring the first data then 1000hrs data	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Low temperature JIS C 0020	*Temperature : -40°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.



SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

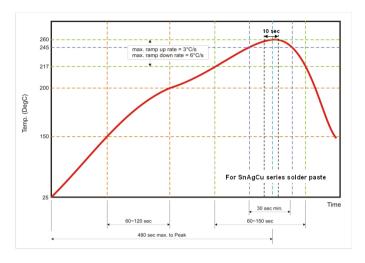


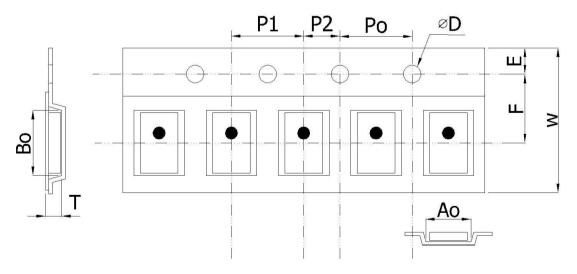
Fig 2. Infrared soldering profile

ORDERING CODE

RF	DIP	201209	0	G	M1T58
Walsin	Product Code	Dimension code	Unit of	Application	Specification
RF device	DIP : Diplexer	Per 2 digits of Length, Width,	dimension	G: GSM850/	Design code
		Thickness:	0 : 0.1 mm	PCS 1900	
		e.g. :	1 : 1.0 mm		
		201209 =			
		Length 20,			
		Width 12,			
		Thickness 09			

Minimum Ordering Quantity: 2000 pcs per reel.

PACKAGING

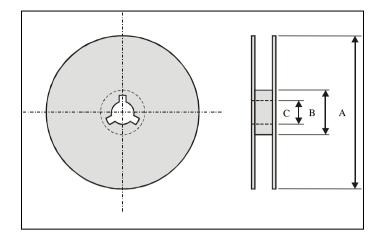


Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	1.42 ± 0.10	2.25 ± 0.10	1.55 ± 0.05	0.95 ± 0.10	8.0 ± 0.10
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05



Reel dimensions



Index	А	В	С
Dimension (mm)	Ф178.0	Ф60.0	Ф13.0

Taping Quantity:2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

■ Temperature : +5 to +40°C

Humidity : 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.